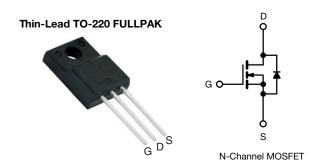
Vishay Siliconix

HALOGEN

FREE

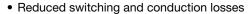
EF Series Power MOSFET With Fast Body Diode



PRODUCT SUMMAR	Y	
V _{DS} (V) at T _J max.	85	50
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 \text{ V}$	0.305
Q _g max. (nC)	5	4
Q _{gs} (nC)	7	7
Q _{gd} (nC)	1	5
Configuration	Sin	gle

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low effective capacitance (Co(er))



Avalanche energy rated (UIS)

 Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	Thin-Lead TO-220 FULLPAK
Lead (Pb)-free and halogen-free	SiHA15N80AEF-GE3

ABSOLUTE MAXIMUM RATINGS (TC	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage		V _{DS}	800		
Gate-source voltage		V _{GS} ± 30		v	
Continuous drain current (T,I = 150 °C) e	V _{GS} at 10 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$	1	6	
Continuous drain current (1j = 150 °C)	V _{GS} at 10 V	T _C = 100 °C	I _D	4	Α
Pulsed drain current ^a			I _{DM}	28	
Linear derating factor				0.26	W/°C
Single pulse avalanche energy b			E _{AS}	28	mJ
Maximum power dissipation			P_{D}	33	W
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope $T_J = 125^{\circ}$		T _J = 125 °C	-1 (-1)	100)//n n
Reverse diode dv/dt ^d			dv/dt	15	- V/ns
Soldering recommendations (peak temperature) c		For 10 s	-	260	°C
Mounting torque	M3 s	screw	-	0.6	Nm

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 1.4 A
- c. 1.6 mm from case
- d. $I_{SD} \le I_D$, di/dt = 100 A/ μ s, starting T_J = 25 °C
- e. Limited by maximum junction temperature



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THERMAL RESISTANCE RATI	NGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R_{thJA}	-	65	°C/W
Maximum junction-to-case (drain)	R_{thJC}	-	3.8	G/ VV

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	800	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.7	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	2	-	4	V
Only and and and		,	V _{GS} = ± 20 V		-	± 100	nA
Gate-source leakage	I_{GSS}	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
Zava gata valtaga dvain avvvant		V _{DS} =	: 640 V, V _{GS} = 0 V	-	-	1	μΑ
Zero gate voltage drain current	I _{DSS}	V _{DS} = 640 V	', V _{GS} = 0 V, T _J = 125 °C	-	-	2	mA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 6.5 A	-	0.305	0.350	Ω
Forward transconductance ^a	9 _{fs}	V _{DS} :	= 10 V, I _D = 6.5 A	-	7.0	-	S
Dynamic							
Input capacitance	C _{iss}	$V_{GS} = 0 V$,		-	1128	-	pF
Output capacitance	C _{oss}	╡ ,	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$		41	-	
Reverse transfer capacitance	C _{rss}	f = 1 MHz		-	5	-	
Effective output capacitance, energy related	C _{o(er)}	V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	34	-	
Effective output capacitance, time related	C _{o(tr)}			-	209	-	
Total gate charge	Qg			-	36	54	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$I_D = 6.5 \text{ A}, V_{DS} = 640 \text{ V}$	-	7	-	nC
Gate-drain charge	Q _{gd}			-	15	-	
Turn-on delay time	t _{d(on)}			-	14	28	
Rise time	t _r	V _{DD} = 640 V, I _D = 6.5 A,		-	14	28	
Turn-off delay time	t _{d(off)}	V _{GS} =	= 10 V, R_g = 9.1 Ω	-	18	36	ns
Fall time	t _f		1		43	86	
Gate input resistance	R_g	f = 1 MHz, open drain		0.2	0.5	1.1	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	6	
Pulsed diode forward current	I _{SM}			-	-	28	А
Diode forward voltage	V _{SD}	T _J = 25 °C	C, I _S = 6.5 A, V _{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}			-	104	208	ns
Reverse recovery charge	Q _{rr}	$T_J = 25$	5 °C, I _F = I _S = 6.5 A,	-	0.4	0.8	μC
Reverse recovery current	I _{RRM}	di/dt = 100 A/μs, V _R = 25 V		-	8	-	A



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

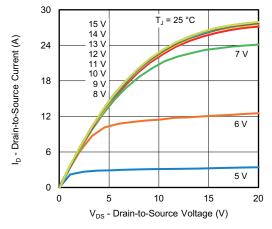


Fig. 1 - Typical Output Characteristics

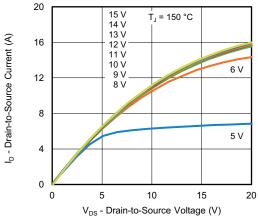


Fig. 2 - Typical Output Characteristics

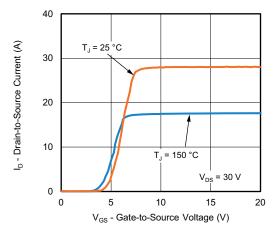


Fig. 3 - Typical Transfer Characteristics

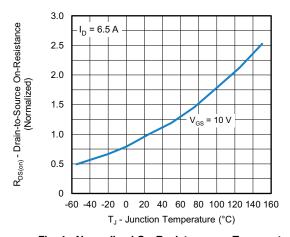


Fig. 4 - Normalized On-Resistance vs. Temperature

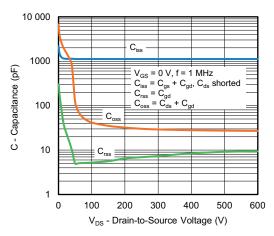


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

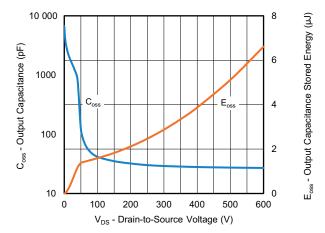


Fig. 6 - Coss and Eoss vs. VDS



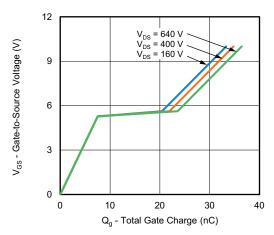


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

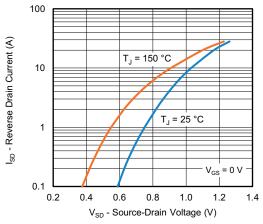


Fig. 8 - Typical Source-Drain Diode Forward Voltage

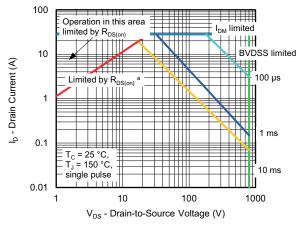


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

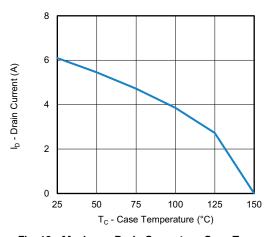


Fig. 10 - Maximum Drain Current vs. Case Temperature

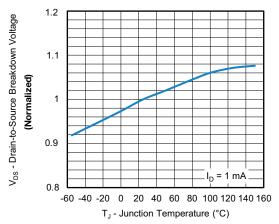


Fig. 11 - Temperature vs. Drain-to-Source Voltage



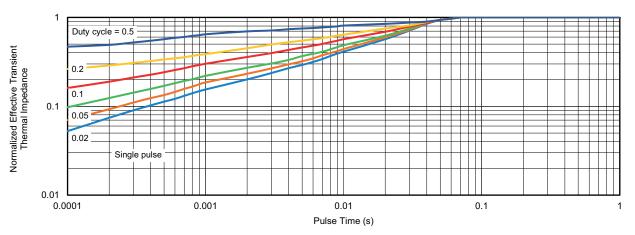


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

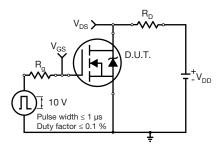


Fig. 13 - Switching Time Test Circuit

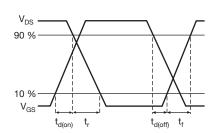


Fig. 14 - Switching Time Waveforms

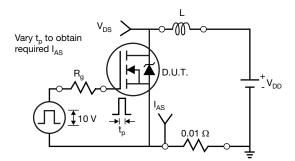


Fig. 15 - Unclamped Inductive Test Circuit

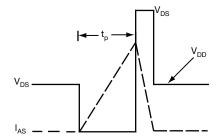


Fig. 16 - Unclamped Inductive Waveforms

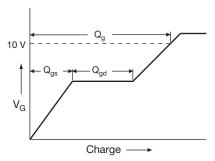


Fig. 17 - Basic Gate Charge Waveform

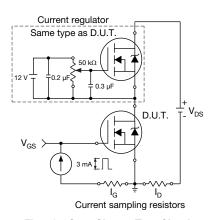


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dv/dt Test Circuit

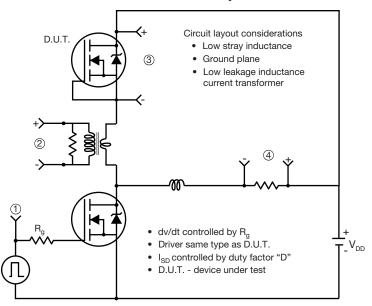




Fig. 19 - For N-Channel

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TO-220 FULLPAK Thin Lead





SYMBOL		DIMEN	ISIONS	
	MILLIN	IETERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134

ECN: E20-0684-Rev. D, 28-Dec-2020

DWG: 6021



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Vishay

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